"E SE DOMANI ..."
Una storia di ... Stampanti

ALLEGATO 3

Presentazione di Angelo Giorgetti

"High End SIMD Printing: Surviving the Challenge"

(1994)

BIS - PRINTER AND COLOUR CONFERENCE - NICE, 7 JUNE 1994

HIGH END SIDM PRINTING: SURVIVING THE CHALLENGE

ANGELO GIORGETTI
Director, Compuprint Division Planning & System Engineering
BULL HN INFORMATION SYSTEMS ITALIA

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HIGH END SIDM PRINTING: SURVIVING THE CHALLENGE

- THE MARKET SCENARIO
- THE CHALLENGE
- AN INNOVATIVE APPROACH



HIGH END SIDM PRINTING: SURVIVING THE CHALLENGE

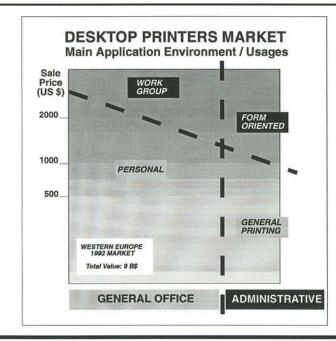
THE MARKET SCENARIO

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DESK TOP PRINTERS - MARKET SCENARIO



GROWING MARKET for GENERAL OFFICE APPLICATIONS



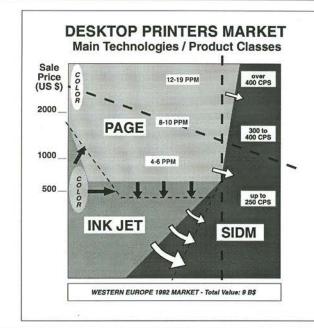
STABLE MARKET for ADMINISTRATIVE APPLICATIONS







DESK TOP PRINTERS - TECHNOLOGIES



WHICH FUTURE for S.I.D.M.

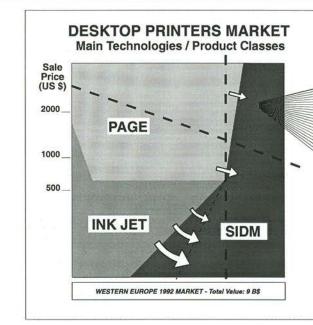
?

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HIGH END S.I.D.M. MARKET



WHICH FUTURE for HIGH END S.I.D.M.

?



HIGH END S.I.D.M. - WHY?

A BULL COMPUPRINT SURVEY ON 50 U.S. USERS OF 400+ CPS SIDMs

→ PURCHASING REASONS

1st - OVERALL COSTS

2nd - FORM CAPABILITIES

14% WOULD CONSIDER A LASER PRINTER FOR THE FUTURE

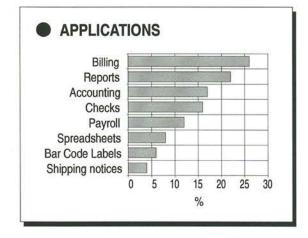
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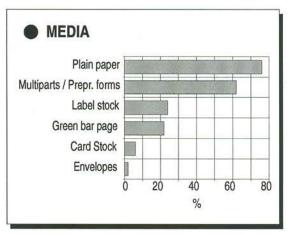
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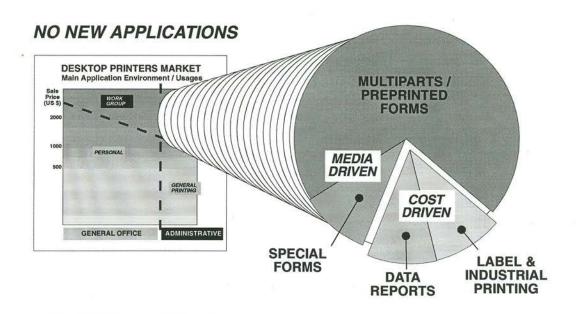
HIGH END S.I.D.M. PRINTING - WHAT?

A BULL COMPUPRINT SURVEY ON 50 U.S. USERS OF 400+ CPS SIDMs





HIGH END S.I.D.M. - THE DRIVING APPLICATIONS



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HIGH END S.I.D.M. - THE DRIVING APPLICATIONS

MULTIPARTS/ PREPRINTED FORMS

- Invoices and billing
- Order forms
- Checks and negotiables

WILL REMAIN a STRONG MARKET for HIGH END SIDMs:

- Copies Colour Preprinted Forms

SPECIAL **FORMS**

- Card stock
- Extra Wide paper

WILL REMAIN AN IMPORTANT APPLICATION for HIGH END SIDMs

DATA REPORTS

NO MORE THE MOST IMPORTANT

- long reports disappear
 short reports printed on non-dedicated printers

SIDM STILL REQUIRED for

- reliability
- cost/pageservicing

LABEL & INDUSTRIAL PRINTING

SMALL NICHE

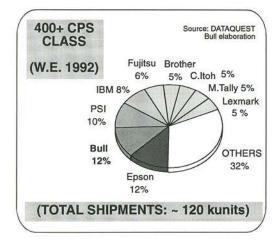
- Cost of Ownership versus dedicated thermal transfer line printers (3-10 IPS)

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HIGH END S.I.D.M. - THE FRAGMENTED INDUSTRY OFFER



MORE THAN 14 MANUFACTURERS



6 VENDORS TO SERVE 50% OF THE MARKET

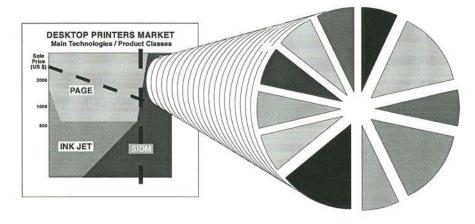


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HIGH END S.I.D.M. MARKET



MATURE

NO NEW APPLICATIONS
NEGATIVE GROWTH RATE



FRAGMENTED
DIFFERENT APPROACHES

MANY VENDORS

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HIGH END S.I.D.M. MARKET

THE MANUFACTURER DILEMMA

WHICH INDUSTRIAL STRATEGY



DIVEST



MAINTAIN



INVEST

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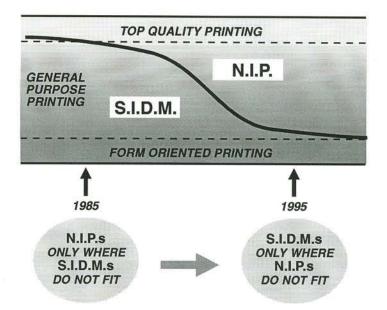


HIGH END SIDM PRINTING: SURVIVING THE CHALLENGE

THE CHALLENGE



THE S.I.D.M. FUTURE



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THE S.I.D.M. FUTURE

N.I.P.S ONLY WHERE S.I.D.M.S DO NOT FIT



S.I.D.M.s ONLY WHERE N.I.P.S DO NOT FIT

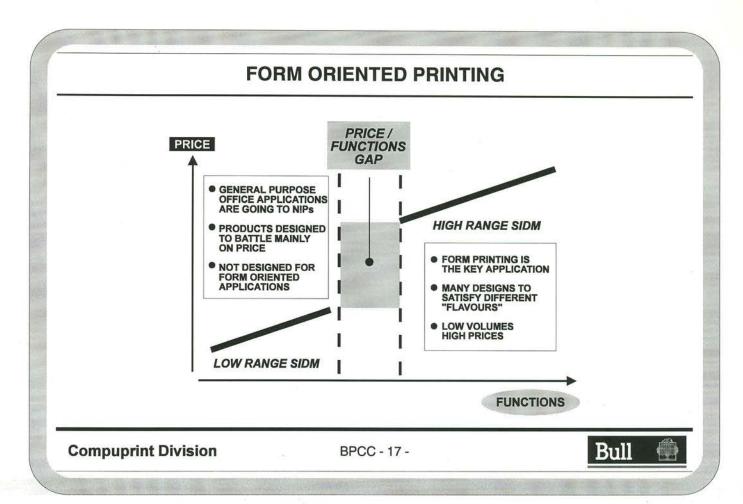


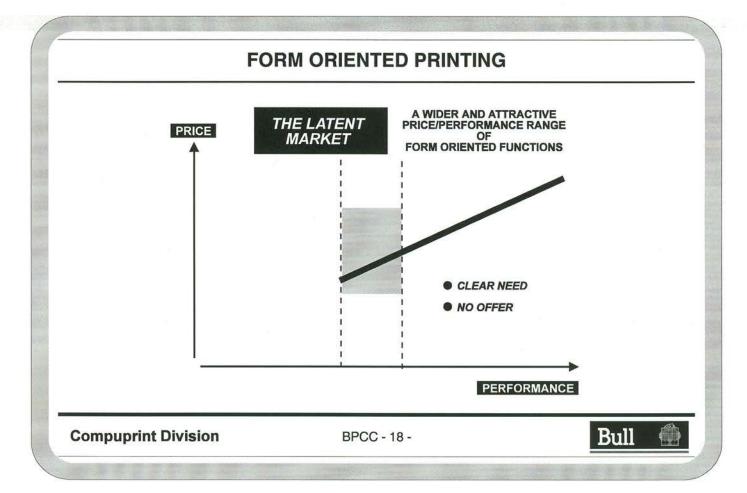
REDEFINE THE S.I.D.M. MARKET AS FORM ORIENTED PRINTING

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THE CHALLENGE

SERVE THE FORM ORIENTED PRINTING LATENT MARKET

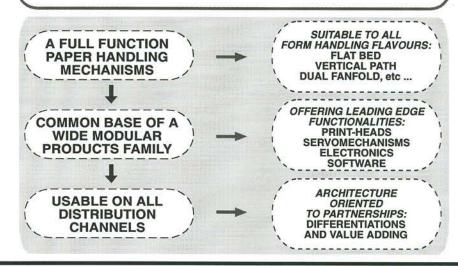
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FORM ORIENTED PRINTING MARKET

a NEW PLATFORM INVESTMENT as a GLOBAL INDUSTRIAL RESPONSE



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HIGH END SIDM PRINTING: SURVIVING THE CHALLENGE

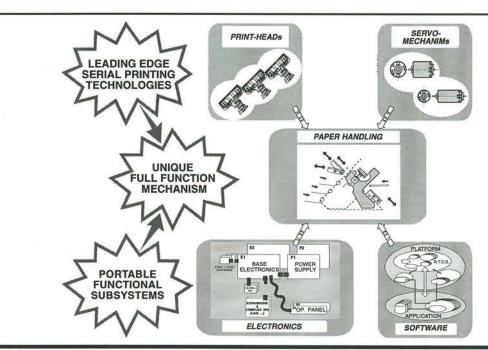
AN INNOVATIVE APPROACH

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AN INNOVATIVE APPROACH - THE VEGA ARCHITECTURE



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AN INNOVATIVE APPROACH - THE VEGA ARCHITECTURE

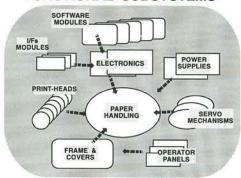
A NEW LEVEL OF MODULARITY

MODELS SUBSYSTEMS MATRIX

	Mod L-9	Mod M-9
SOFTWARE	S1	S1
OPERATOR PANEL	00	00
ELECTRONICS	E1	E1
POWER SUPPLY	PO	P1
PRINT-HEAD	T1	T2
SERVO MECHANISMS	A1	A2
PAPER HANDLING	Н1	H2
FRAME	C1	C1

Mod L-24	Mod M-24	Mod H-24	Mod H-18	Mod T-18
S1	S1	S1	S1	S1
01	01	02	01	02
E1	E1	E2	E2	E2
P1	P1	P2	P2	P2
ТЗ	T4	T5	Т6	T7
A1	A2	АЗ	A2	АЗ
Н1	H2	H2	H2	H2
C1	C1	C1	C1	C1

FUNCTIONAL SUBSYSTEMS



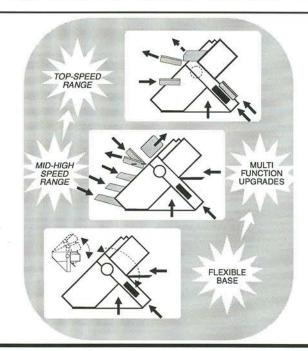
SUBSYSTEMS ARCHITECTURAL TECHNOLOGICAL PHYSICAL

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AN INNOVATIVE APPROACH - THE VEGA ARCHITECTURE



A NEW
FULL FUNCTION
PAPER HANDLING
MECHANISM

COMMON TO DIFFERENT FUNCTIONS AND SPEEDS

ARCHITECTURAL DESIGN for UPGRADING and PERSONALIZATION

TECHNOLOGICAL SOLUTIONS for RE-USABILITY and DERIVATIONS

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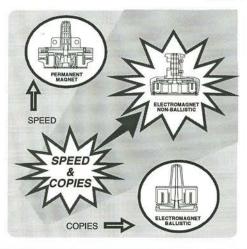
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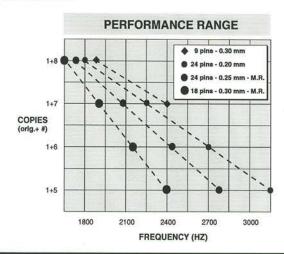


AN INNOVATIVE APPROACH - THE VEGA ARCHITECTURE

A NEW PRINT-HEADS FAMILY

9-18-24 PINS IMPROVED COST / PERFORMANCE



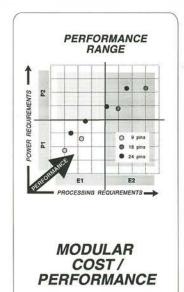


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AN INNOVATIVE APPROACH - THE VEGA ARCHITECTURE



COMMON ARCHITECTURAL & PHYSICAL BASES to different TECHNOLOGICAL SOLUTIONS TECHNOLOGICAL SOLUTIONS E1 19 bb bb - Mail ASC Architectural (up to 380 W) E1 19 bb bb - Mail ASC Architectural (up to 200 W) FONT / CODE BASE EXPANSIONS EXPANSIONS EXPANSIONS EXPANSIONS EXPANSIONS EXPANSIONS SUPPLY SERVICE STRUCTURE STRUCTURE STRUCTURE

ELECTRONICS

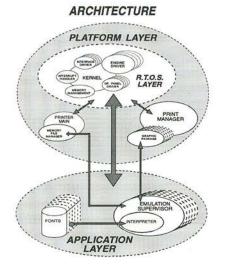
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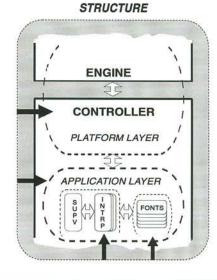


AN INNOVATIVE APPROACH - THE VEGA ARCHITECTURE

SOFTWARE



PORTABLE & OPEN

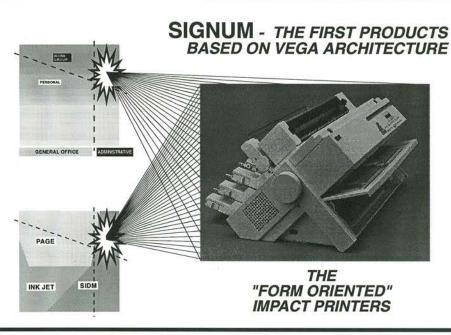


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AN INNOVATIVE APPROACH



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